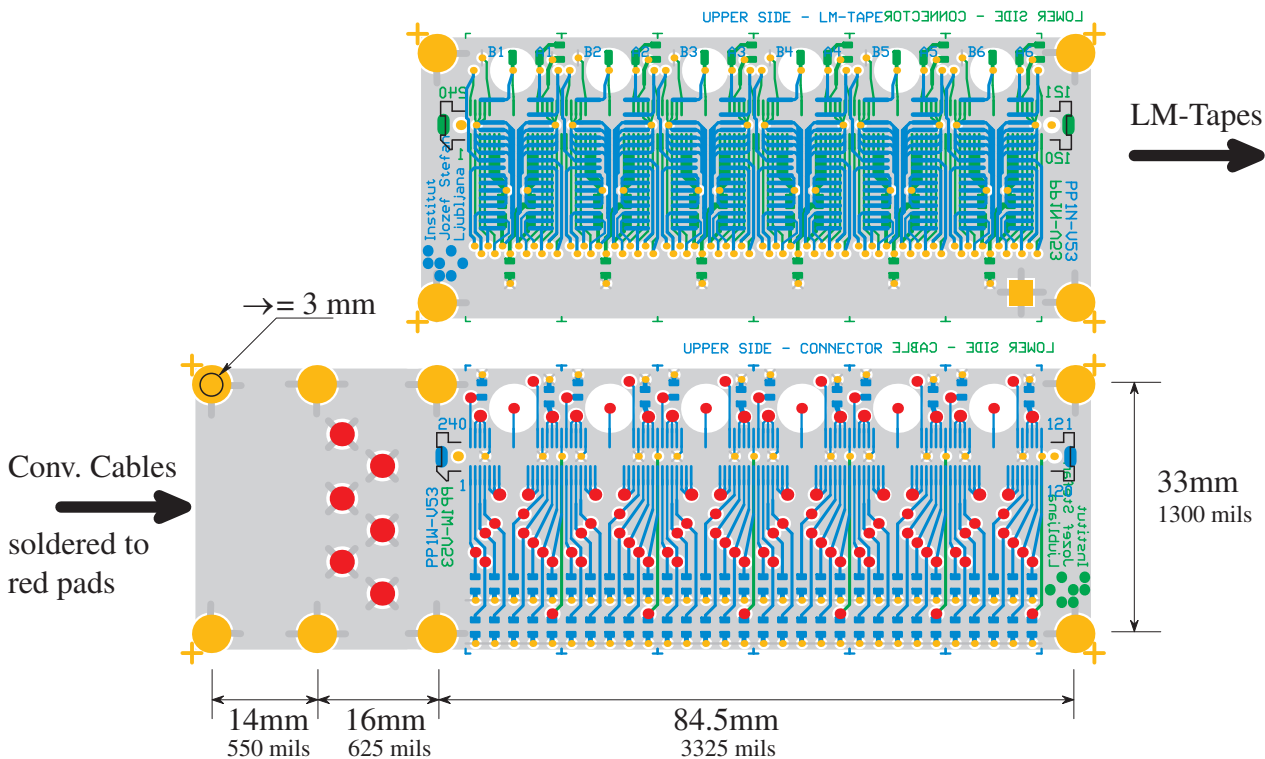


Patch-Panel-1 PCB ver.5.3

Date : 2001-11-27

Last changes :

- 1) Low-Mass-Tape solder pads width : 0.6mm, length 3.5mm (already in V5.2)
- 2) Conventional Cable Clip and Shield solder pads moved from the right to the left (due to mounting orientation).
- 3) Mounting screws connected to the ground-plane (shield) layer.
- 4) Added 1 pin for Vdd and DGnd at the Molex connector (due to increased current rating of 1.3A on the digital supply).



Board dimensions :
 PP1-W : 120 x 38 mm
 PP1-N : 90 x 38 mm



Thickness : 2 mm

Note :

Due to the 2.5 mm spacing of pins under the Molex connector the HV pin and the pins on the left side of it in each section had to be moved to conform with the requirement. Consequently, versions 5.x are incompatible with any other version previous to 5.